Low Cost Infrared 2200 Watt BGA Rework System Model I760-B

**Low Cost Effective BGA Rework System for service industry**

**I760B Scope of Supply**
- I760B System with top/bottom IR Units
- User Manual
- Software
- RS232 & Power Cable

**Applications**
- Repair of laptops, mobiles
- Service Centers
- BGA Rework in Industries & Labs

**Unique Features**
- Focused Infrared heating delivers heat at the right place. No effect on adjacent components
- IR Pre-Heater 260x260 mm, 1500 W
- Programmable profiles: For precise rework process. (Pre-heating, Soak, Reflow and cooling stages)
- Closed-loop temperature control for precise temperatures
- PC based software: To monitor the process
- Laser Pointer: for positioning component PCB
- PCB Holder: with smooth X-Y movement (for model I760-DX)
- Can rework SMD, BGA, CSP, PGA, Sockets

**Specifications**
- Power: 2200 Watt
- Voltage Range: 230 V, 50Hz
- Top IR Heater: 720 Watt, 60x60 mm size
- Top Heater Range: 20 ~ 60 mm
- Bottom Preheater: 1500 Watt (Infrared type)
- Bottom Preheater: 260x260 mm
- Heating time of top preheater: 10 sec (ambient ~ 230°C)
- Communication: RS-232 for PC connection
- Infrared temp. sensor: 0~300°C
- Outside K-type sensor: optional
- LCD Display: 16x2 character, 66x23.5 mm
- Dimensions(LxWxH): 330x380x440 mm (approx.)